



CERTIFICATE



This is to certify that

SIGURD MICROELECTRONICS CORPORATION

No. 1, Siwei Road, Hsinchu Industrial Park, Hukou
Hsin-Chu
Taiwan

with the organizational units/sites as listed in the annex

has implemented and maintains an **Electrostatic Discharge Control Program**.

Scope:

The production testing of integrated circuits in wafer and package form.
The manufacture of integrated circuit device trimming.
The manufacture of wafer grinding and DPS (Die and Pick place Service).

Through an audit, documented in a report, it was verified that the management system fulfills the requirements of the following standard:

ANSI/ESD S20.20-2021

Certificate registration no.	20002757 ESD-2021
Date of certification	2024-07-16
Valid until	2025-07-18
Lead Auditor	Derrick Hsu
ESD Program Manager	Arthur Lee
Technical Reviewer	Carlton Patterson



DQS Inc.

David Tellez
Managing Director



Accredited Body: DQS Inc., 1500 McConnor Parkway, Suite 400, Schaumburg, IL 60173 USA
Administrative Office: DQS Taiwan Inc., 8F, 23, Yuan Huan West Road, Feng Yuan Dist.,
Taichung City, Taiwan 420
The validity of the certification can only be verified by the QR-code.



Annex to certificate
Registration No. 20002757 ESD-2021

SIGURD MICROELECTRONICS CORPORATION

No. 1, Siwei Road, Hsinchu Industrial Park, Hukou
Hsin-Chu
Taiwan

Location

Scope

20002757

SIGURD MICROELECTRONICS CORPORATION
No. 1, Siwei Road, Hsinchu Industrial Park
Hukou, Hsin-Chu
Taiwan

The production testing of integrated circuits in
wafer and package form.
The manufacture of integrated circuit device
trimming.

50600370

SIGURD MICROELECTRONICS CORPORATION
No. 11 LANE 169, SEC. 2
CHUNG-SHING RD., CHU-TUNG
HSIN-CHU
TAIWAN, R.O.C.

The production testing of integrated circuits in
wafer and package form.
The manufacture of integrated circuit device
trimming.
The manufacture of wafer grinding and DPS
(Die and Pick place Service).

20004697

SIGURD MICROELECTRONICS CORPORATION
No. 436 SEC. 1
PEI-SHING RD., CHU-TUNG
HSIN-CHU
TAIWAN, R.O.C.

The production testing of integrated circuits in
wafer and package form.
The manufacture of integrated circuit device
trimming.

50600400

SIGURD MICROELECTRONICS CORPORATION
3F, No. 65, Guangfu N. Rd.
HSINCHU INDUSTRIAL PARK, HUKOU
HSIN-CHU
TAIWAN, R.O.C.

The production testing of integrated circuits in
wafer and package form.
The manufacture of integrated circuit device
trimming.